

MOSFET - Power, Single **N-Channel**

100 V, 3.9 mΩ, 138 A

NVMFWS004N10MC

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free, Beryllium Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	100	V
Gate-to-Source Voltage	Э		V_{GS}	±20	V
Continuous Drain	Steady	T _C = 25°C	I _D	138	Α
Current R _{θJC} (Note 1)		T _C = 100°C	1	98	
Power Dissipation	State	T _C = 25°C	P _D	164	W
R _{θJC} (Note 1)		T _C = 100°C	1	82	
Continuous Drain		T _A = 25°C	I _D	21	Α
Current R _{θJA} (Notes 1, 2)	Steady	T _A = 100°C		15	
Power Dissipation	State	T _A = 25°C	P_{D}	3.8	W
R _{θJA} (Notes 1, 2)		T _A = 100°C		1.9	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	900	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			I _S	126	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 9.2 A)		E _{AS}	536	mJ	
Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C	

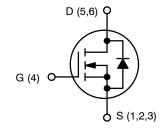
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	0.91	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

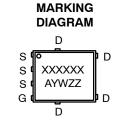
^{1.} The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
100 V	3.9 mΩ @ 10 V	138 A



N-CHANNEL MOSFET





= Assembly Location

= Year

W = Work Week = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

^{2.} Surface-mounted on FR4 board using 1 in2 pad size, 2 oz. Cu pad.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /	I_D = 250 μ A, ref to 25°C			56		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	I_{DSS} $V_{GS} = 0 \text{ V},$ $T_{J} = 25^{\circ}\text{C}$				1	μΑ
		$V_{DS} = 100 \text{ V}$	T _J = 125°C			100	1
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	= 20 V			100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	= 270 μA	2		4	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 250 μA, ref	to 25°C		-9.1		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 48 A			3.3	3.9	mΩ
Forward Transconductance	9FS	V _{DS} = 10 V, I _D	= 48 A		120		S
CHARGES & CAPACITANCES	-						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 50 V			3600		pF
Output Capacitance	C _{OSS}				1700		1
Reverse Transfer Capacitance	C _{RSS}				30		1
Total Gate Charge	Q _{G(TOT)}				48		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 50 V, I _D = 48 A			11		
Gate-to-Source Charge	Q _{GS}				18		1
Gate-to-Drain Charge	Q_{GD}				8		1
Plateau Voltage	V_{GP}				5.2		V
SWITCHING CHARACTERISTICS (Note 3	3)						
Turn-On Delay Time	t _{d(ON)}				25		ns
Rise Time	t _r	VGS = 10 V. VDS	s = 50 V.		18		1
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 10 V, V_{DS} = 50 V, I_{D} = 48 A, R_{G} = 6 Ω			39		1
Fall Time	t _f				13		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C		0.84	1.3	V
		VGS - 0 V,	T _J = 125°C		0.73		
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, di/dt = 100 A/ μ s, I_S = 24 A			65		ns
Reverse Recovery Charge	Q _{RR}				73		nC
Charge Time	t _S				30		ns
Discharge Time	t _D				35		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS

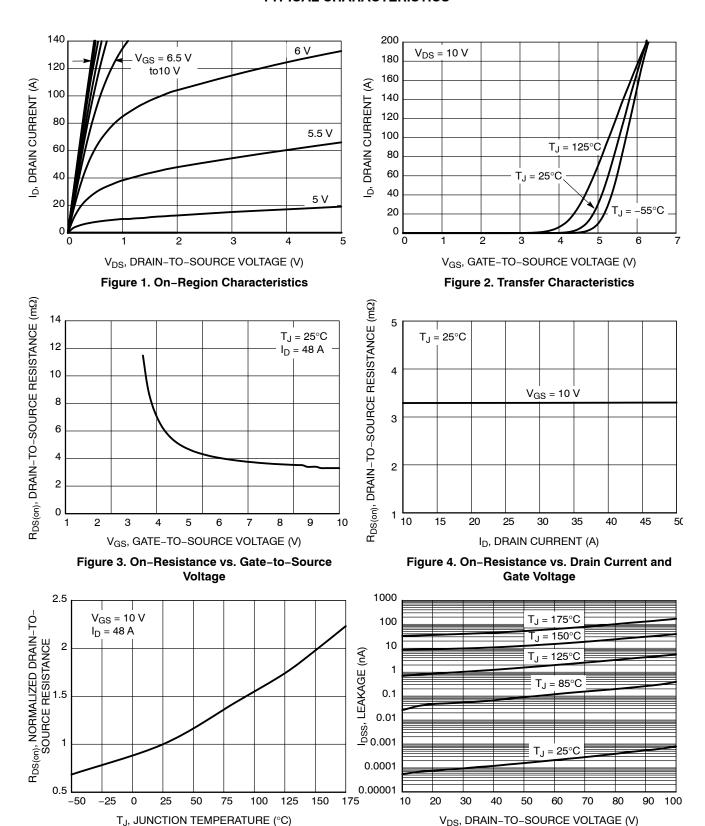


Figure 6. Drain-to-Source Leakage Current

vs. Voltage

Figure 5. On-Resistance Variation with

Temperature

TYPICAL CHARACTERISTICS

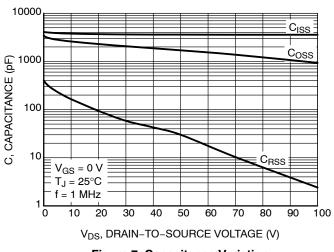


Figure 7. Capacitance Variation

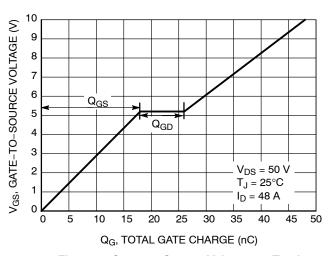


Figure 8. Gate-to-Source Voltage vs. Total Charge

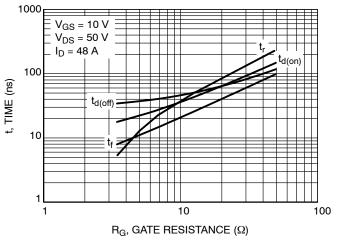


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

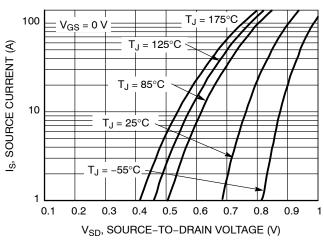


Figure 10. Diode Forward Voltage vs. Current

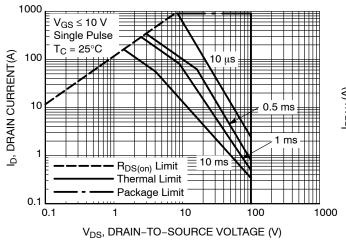


Figure 11. Maximum Rated Forward Biased Safe Operating Area

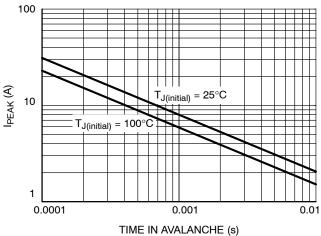


Figure 12. $I_{\mbox{\scriptsize PEAK}}$ vs. Time in Avalanche

TYPICAL CHARACTERISTICS

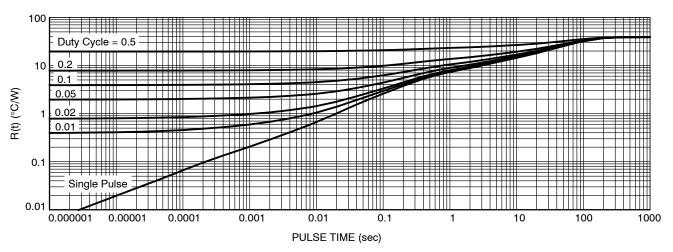


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFWS004N10MCT1G	004W10	Wettable Flank DFN5 (Pb-Free)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

IDENTIFIER





CASE 507BA **ISSUE A**



MILLIMETERS

N□M.

0.575

0.575

0.150 REF

1.35

MAX. 1.10 0.05 0.51

0.33

5.30 5.10

4.20

6.30 6.10

3.85

0.71

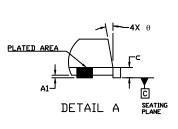
1.50

0.71



DIM

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
CONTROLLING DIMENSION: MILLIMETERS
DIMENSIONS DI AND EI DO NOT INCLUDE MOLD FLASH,
PROTRUSIONS, OR GATE BURRS.
THIS PACKAGE CONTAINS WETTABLE FLANK DESIGN
FEATURES TO AID IN FILLET FORMATION ON THE LEADS DURING MOUNTING.



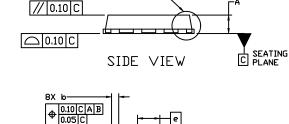
Α	0.90	1.00
A1	0.00	
b	0.33	0.41
С	0.23	0.28
D	5.00	5.15
D1	4.70	4.90
D2	3.80	4.00
Е	6.00	6.15
E1	5.70	5.90
E2	3.45	3.65
е		1.27 BSC

0.51

1.20

0.51

MIN



e/2

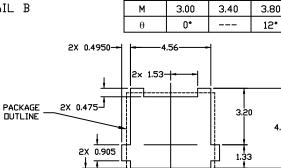
BOTTOM VIEW

-DETAIL B

DETAIL A

TOP VIEW





0.965

4X 1.00-

G

Κ

L1

GENERIC MARKING DIAGRAM*

PIN 5 (EXPOSED PAD)



= Assembly Location Α

Υ = Year W

ZZ

= Work Week = Lot Traceability

XXXXXX = Specific Device Code *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " =", may or may not be present. Some products

may not follow the Generic Marking.

RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the $\square N$ Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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4X 0.75

DESCRIPTION: DFNW5 5x6 (FULL-CUT SO8FL WF) **PAGE 1 OF 1**

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